

5 Ld Voltage Supervisors with Adjustable Power-On Reset, Dual Voltage Monitoring or Watchdog Timer Capability

The ISL88011 through ISL88015 family of devices offer both fixed and/or adjustable voltage-monitoring that combine popular functions such as Power On Reset control, Watchdog Timer, Supply Voltage Supervision, and Manual Reset assertion in a small 5 Ld SOT-23 package.

Unique features on the ISL88013 and ISL88015 include a watchdog timer with a 51s startup timeout and a 1.6s normal timeout duration. On the ISL88011 and ISL88014, users can increase the nominal 200ms Power On Reset timeout delay by adding an external capacitor to the C_{POR} pin. Both fixed and adjustable voltage monitors are provided by the ISL88012. Complementary active-low and active-high reset outputs are available on the ISL88011, ISL88012 and ISL88013 devices. All devices provide manual reset capability (see "Product Features Table" on page 4).

Seven preprogrammed reset threshold voltages accurate to $\pm 1.5\%$ over temperature are offered (see "Ordering Information" on page 3). The ISL88012, ISL88014 and ISL88015 have a user-adjustable voltage input available for custom monitoring of any voltage down to 0.6V. All parts are specifically designed for low power consumption and high threshold accuracy.

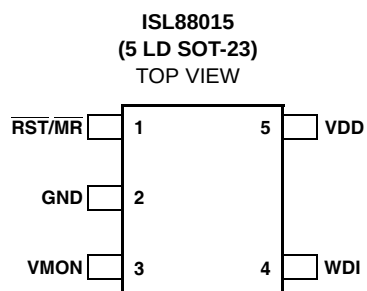
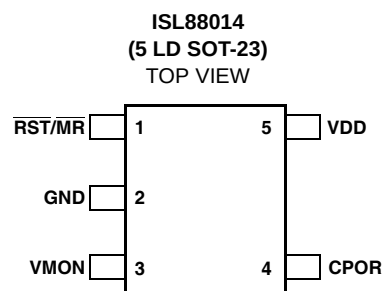
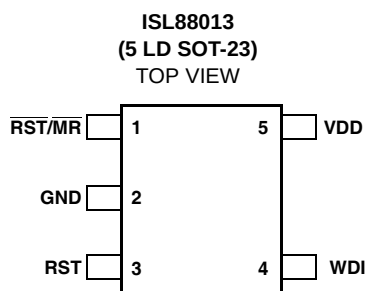
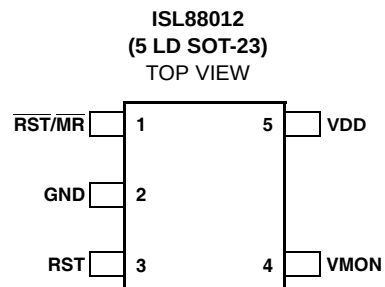
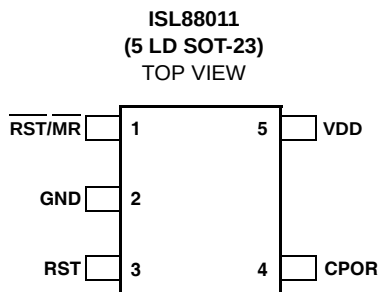
Features

- Single/Dual Voltage Monitoring Supervisors
- Fixed-Voltage Options Allow Precise Monitoring of +2.5V, +3.0V, +3.3V, and +5.0V Power Supplies
- Dual Supervisor Has One Fixed Voltage Input and Another That is User-Adjustable Down to 0.6V.
- Both RST and $\overline{\text{RST}}$ Outputs Available
- Adjustable POR Timeout Delay Options
- Watchdog Timer With 1.6s Normal and 51s Startup Timeout Durations
- Manual Reset Input on All Devices
- Reset Signal Valid Down to V_{DD} = 1V
- Accurate $\pm 1.5\%$ Voltage Threshold
- Immune to Power-Supply Transients
- Ultra Low 5.5 μ A Supply Current
- Small 5 Ld SOT-23 Pb-Free Package
- Pb-Free Plus Anneal Available (RoHS Compliant)

Applications

- Process Control Systems
- Intelligent Instruments
- Embedded Control Systems
- Computer Systems
- Critical μ P and μ C Power Monitoring
- Portable/Battery-Powered Equipment
- PDA and Handheld PC Devices

Pinouts



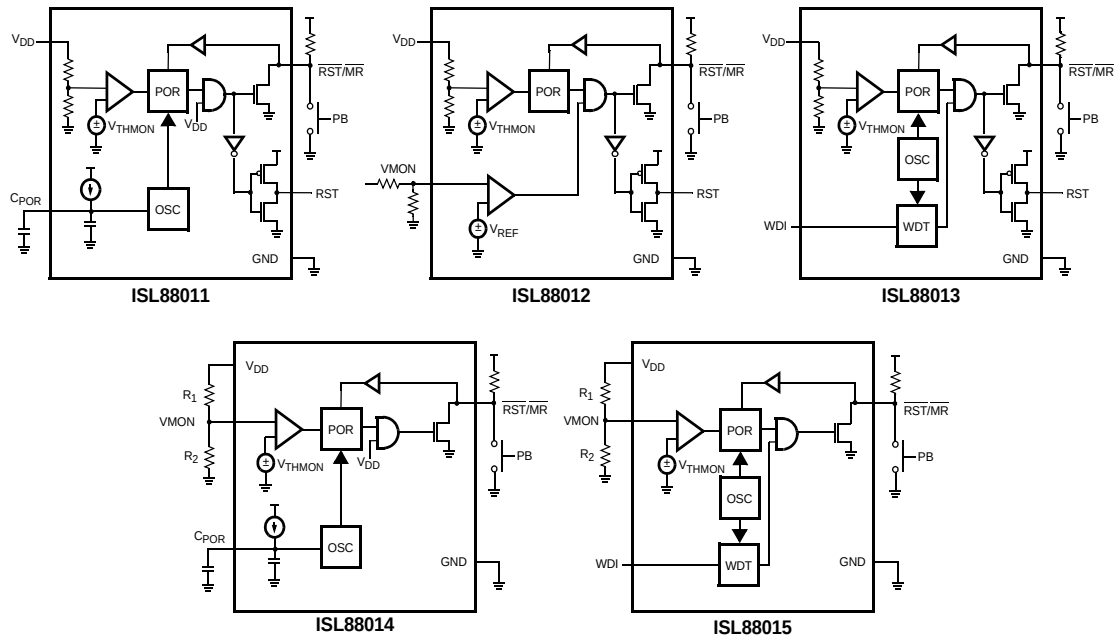
Ordering Information

PART NUMBER (Notes 1, 2)	PART MARKING	V _{THVDD} (V)	V _{THVMON} (V)	TEMPERATURE RANGE (°C)	PACKAGE TAPE AND REEL (Pb-free)	PKG. DWG. #
ISL88011IH546Z-TK	AGU	4.64	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88011IH544Z-TK	AGV	4.38	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88011IH531Z-TK	AGW	3.09	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88011IH529Z-TK	AGX	2.92	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88011IH526Z-TK	AGY	2.63	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88011IH523Z-TK	AGZ	2.32	N/A	-40 to +85	5 Ld SOT-23)	P5.064
ISL88011IH522Z-TK	AHE	2.19	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH546Z-TK	AHF	4.64	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH544Z-TK	AHG	4.38	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH531Z-TK	AHH	3.09	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH529Z-TK	AHI	2.92	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH526Z-TK	AHJ	2.63	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH523Z-TK	AHK	2.32	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88012IH522Z-TK	AHL	2.19	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH546Z-TK	AHM	4.64	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH544Z-TK	AHN	4.38	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH531Z-TK	AHO	3.09	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH529Z-TK	AHP	2.92	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH526Z-TK	AHQ	2.63	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH523Z-TK	AHR	2.32	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88013IH522Z-TK	AHS	2.19	N/A	-40 to +85	5 Ld SOT-23	P5.064
ISL88014IH5Z-TK	AHT	N/A	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064
ISL88015IH5Z-TK	AHU	N/A	0.6 (Note 2)	-40 to +85	5 Ld SOT-23	P5.064

NOTES:

- Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020
- The voltage trip point can be adjusted to be greater than 0.6V using 2 external resistors. By default, the V_{THVMON} trip point is 0.6V if no external resistors are used.

Functional Block Diagrams



Product Features Table

FUNCTION	ISL88011	ISL88012	ISL88013	ISL88014	ISL88015
Active-Low Reset ($\overline{\text{RST}}$)	x	x	x	x	x
Active-High Reset (RST)	x	x	x		
Watchdog Timer (WDI)			x		x
Dual Voltage Supervision		x			
Adjustable POR Timeout (C_{POR})	x			x	
Manual Reset Input ($\overline{\text{MR}}$)	x	x	x	x	x
Fixed Trip Point Voltage	x	x	x		
Adjustable Trip Point Voltage		x		x	x

Pin Descriptions

PIN					NAME	FUNCTION
ISL88011	ISL88012	ISL88013	ISL88014	ISL88015		
1	1	1	1	1	$\overline{\text{RST}}/\overline{\text{MR}}$	Combined Active-Low Reset Output and Manual Reset Input
2	2	2	2	2	GND	Ground
	4		3	3	VMON	Adjustable Threshold Voltage Input
3	3	3			RST	Active-High Reset Output
4			4		C_{POR}	Adjustable POR Timeout Delay Input
		4		4	WDI	Watchdog Timer Input
5	5	5	5	5	V_{DD}	Supply Voltage and Monitored Input

Absolute Maximum Ratings

Temperature under bias -40°C to +125°C
 Storage temperature -65°C to +150°C
 Voltage on any pin with respect to GND -1.0V to +7V
 D.C. output current. 5mA
 Lead temperature (soldering, 10 seconds) +300°C

Recommended Operating Conditions

Thermal Resistance (Typical, Note 3) θ_{JA} (°C/W)
 5 Ld SOT-23. 190
 Maximum Junction Temperature (Plastic Package) +125°C
 Maximum Storage Temperature Range -65°C to +150°C
 Maximum Lead Temperature (Soldering 10s) +300°C
 (SOT-23 Lead Tips Only)

Recommended Operating Conditions

Temperature Range (Industrial) -40°C to +85°C
 Pull-up Resistance (R_{PU}) 5k Ω to 100k Ω

CAUTION: Absolute Maximum Ratings indicate limits beyond which permanent damage to the device and impaired reliability may occur. These are stress ratings provided for information only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification are not implied.

For guaranteed specifications and test conditions, see Electrical Specifications. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

NOTE:

- θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

Electrical Specifications Over the recommended operating conditions unless otherwise specified, $R_{PU} = 10k\Omega$.

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
V_{DD}	Supply Voltage Range		2.0		5.5	V
I_{DD}	Supply Current for ISL88011, ISL88012, ISL88013	$V_{DD} = 5.0V$		8	11.5	μA
		$V_{DD} = 3.3V$		7	10	μA
		$V_{DD} = 2.5V$		5.5	9	μA
	Supply Current for ISL88014, ISL88015	$V_{DD} = 3.3V$		4.5	8	μA
I_{LI}	Input Leakage Current (VMON)				100	nA
I_{LO}	Output Leakage Current (VMON)				100	nA
VOLTAGE THRESHOLDS						
V_{THVDD}	Fixed V_{DD} Voltage Trip Point	ISL88011, 88012, 88013IH546	4.57	4.64	4.71	V
		ISL88011, 88012, 88013IH544	4.31	4.38	4.45	V
		ISL88011, 88012, 88013IH531	3.04	3.09	3.14	V
		ISL88011, 88012, 88013IH529	2.88	2.92	2.96	V
		ISL88011, 88012, 88013IH526	2.59	2.63	2.67	V
		ISL88011, 88012, 88013IH523	2.29	2.32	2.35	V
		ISL88011, 88012, 88013IH522	2.16	2.19	2.22	V
V_{THVDD} HYST	Hysteresis at V_{DD} Input	$V_{THVDD} = 4.64V$		46		mV
		$V_{THVDD} = 4.38V$		44		mV
		$V_{THVDD} = 3.09V$		31		mV
		$V_{THVDD} = 2.92V$		29		mV
		$V_{THVDD} = 2.63V$		26		mV
		$V_{THVDD} = 2.32V$		23		mV
		$V_{THVDD} = 2.19V$		22		mV
V_{THVMON}	Adj. Reset Voltage Trip Point (Note 4)	$V_{THVDD} = 4.64V$	599	605	611	mV
		$V_{THVDD} = 4.38V$	597	603	609	mV
		$V_{THVDD} = 3.09V$	589	595	601	mV
		$V_{THVDD} = 2.92V$	589	595	601	mV
		$V_{THVDD} = 2.63V$	589	595	601	mV
		$V_{THVDD} = 2.32V$	597	603	609	mV
		$V_{THVDD} = 2.19V$	597	603	609	mV
V_{THVMON}	Adj. Reset Voltage Trip Point (Note 5)		594	600	606	mV

Electrical Specifications Over the recommended operating conditions unless otherwise specified, $R_{PU} = 10k\Omega$. (Continued)

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
V_{THVMON} HYST	Hysteresis Voltage (Notes 4, 5)			3		mV
RESET						
V_{OL}	Reset Output Voltage Low	$V_{DD} \geq 3.3V$, Sinking 0.5mA		0.05	0.40	V
		$V_{DD} < 3.3V$, Sinking 0.5mA		0.05	0.40	V
V_{OH}	Reset Output Voltage High	$V_{DD} \geq 3.3V$, Sourcing 0.4mA	$V_{DD}-0.6$	$V_{DD}-0.4$		V
		$V_{DD} < 3.3V$, Sourcing 0.4mA	$V_{DD}-0.6$	$V_{DD}-0.4$		V
t_{RPD}	V_{TH} to Reset Asserted Delay			60		μs
t_{POR}	POR Timeout Delay	ISL88012, ISL88013, ISL88015	140	200	260	ms
		ISL88011, ISL88014 with $C_{POR} = OPEN$	200	250		ms
C_{LOAD}	Load Capacitance on Reset Pins			5		pF
MANUAL RESET						
V_{MR}	$\overline{MR}$ Input Voltage		0		100	mV
t_{MR}	$\overline{MR}$ Minimum Pulse Width		1			μs
WATCHDOG TIMER (Note 6)						
Start t_{WDT}	Startup Watchdog Timeout Period		32	51	64	sec
t_{WDT}	Normal Watchdog Timeout Period		1.0	1.6	2.0	sec
t_{WDPS}	WDI Minimum Pulse Width		100			ns
V_{IL}	Watchdog Input Voltage Low				$0.3 \times V_{DD}$	V
V_{IH}	Watchdog Input Voltage High		$0.85 \times V_{DD}$			V
I_{WDT}	Watchdog Input Current				100	nA

NOTES:

4. Applies to ISL88012
5. Applies to ISL88014 and ISL88015.
6. Applies to ISL88013 and ISL88015.

Pin Description

RST

The push-pull RST output is set to V_{DD} (HIGH) whenever 1) the device is first powered up, 2) either V_{DD} or the voltage on VMON falls below their respective minimum voltage sense levels, 3) $\overline{MR}$ is asserted or 4) the watchdog timeout expires.

$\overline{RST}/\overline{MR}$

This pin functions as both a reset output and a manual reset input. The $\overline{RST}$ output functions identically to the complementary RST output but is an open drain output that is pulled to GND (LOW) when reset is asserted. The $\overline{MR}$ input is an active-low debounced input to which a user can connect a push-button to add manual reset capability or drive with active low signal from a controller.

V_{DD}

The V_{DD} pin is the power supply terminal. It is monitored by the ISL88011, ISL88012 and ISL88013. For these devices, the voltage at this pin is compared against an internal factory-programmed voltage trip point, V_{THVDD} . A reset is first asserted when the device is initially powered up to ensure that the power supply has stabilized. Thereafter, reset is again asserted whenever V_{DD} falls below V_{THVDD} .

The device is designed with hysteresis to help prevent chattering due to noise.

VMON

The VMON pin on the ISL88012, ISL88014 and ISL88015 is a monitored input voltage that is user-adjustable. The voltage at this pin is compared against an internal 600mV reference voltage (V_{THVMON}) and a reset is asserted whenever the monitored voltage falls below this trip point.

WDI

The Watchdog Input takes an input from a microprocessor and ensures that it periodically toggles the WDI pin, otherwise the internal watchdog timer runs out and reset is asserted. The internal Watchdog Timer is cleared whenever the WDI input pin sees a rising or falling edge or the device is manually reset.

C_{POR}

The C_{POR} input pin lets users increase the Power On Reset timeout delay (t_{POR}) by connecting a capacitor between C_{POR} and ground. (See Figure 3)

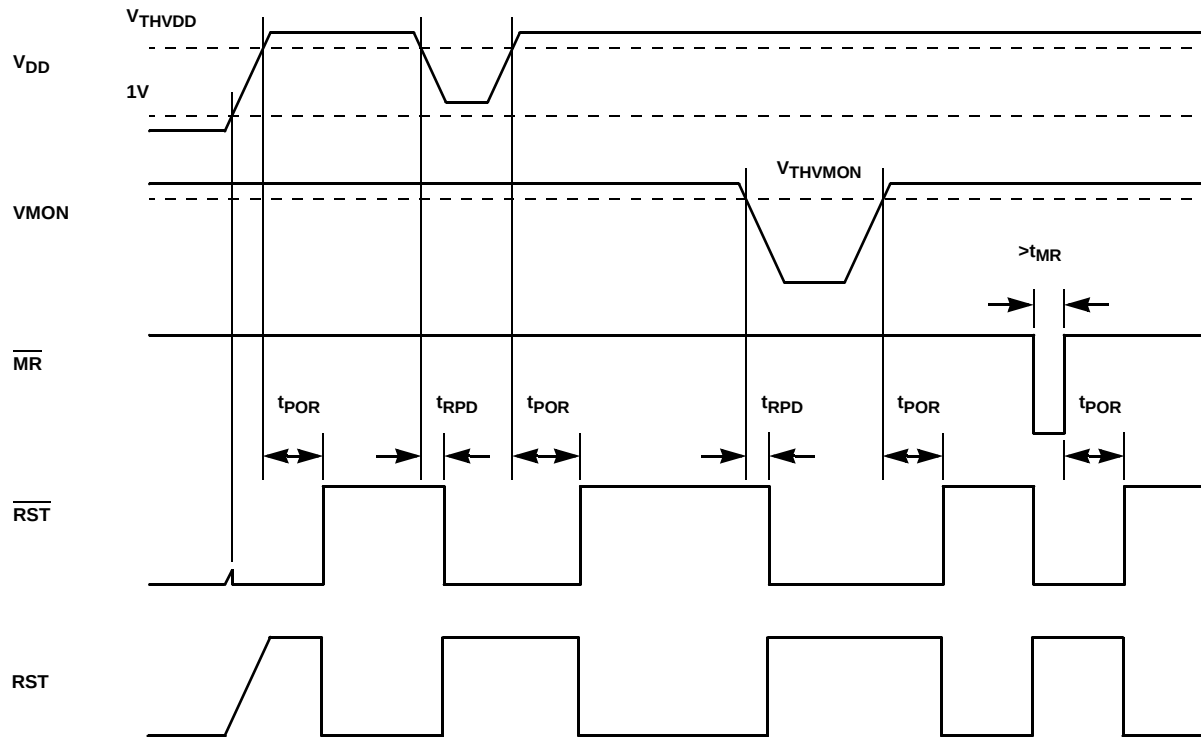


FIGURE 1. VOLTAGE MONITORING TIMING DIAGRAM

Principles of Operation

The ISL88011 through ISL88015 devices provide those functions needed for critical voltage monitoring. These features include Power On Reset control, customizable supply voltage supervision, Watchdog Timer capability, and manual reset assertion. By integrating all of these features into a small 5 Ld SOT-23 package and using only 5.5µA of supply current, the ISL88011 through ISL88015 devices can assist in lowering system cost, reducing board space requirements, and increasing the reliability of a system.

Low Voltage Monitoring

During normal operation, these supervisors monitor both the voltage level of VDD (ISL88011, ISL88012, ISL88013) and/or VMON (ISL88012, ISL88014, ISL88015). The device asserts a reset if any of these voltages falls below their respective trip points. The reset signal effectively prevents the system from operating during a power failure or brownout condition. This reset signal remains asserted until VDD and the voltage on VMON exceed their voltage threshold setting for the reset time delay period tPOR of 200ms (See Figure 1).

The ISL88012, ISL88014 and ISL88015 allow users to customize the minimum voltage sense level on the VMON input pin. To do this, connect an external resistor divider network to the VMON pin in order to set the trip point to some voltage above 600mV according to the following equation (See Figure 2):

$$V_{INTRIP} = 0.6 \times \frac{(R_1 + R_2)}{R_2} \quad (\text{EQ. 1})$$

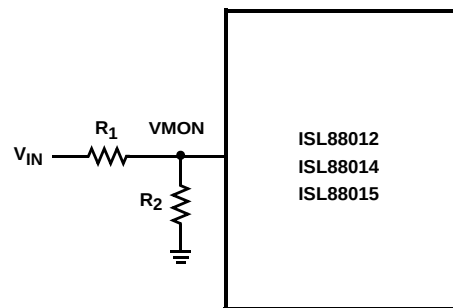


FIGURE 2. USING VMON TO MONITOR VIN VIA RESISTORS

Power On Reset (POR)

Applying at least 1V to the V_{DD} pin activates a POR circuit which asserts reset (i.e. RST goes HIGH while $\overline{RST}$ goes LOW). The reset signals remain asserted until the voltage at V_{DD} and/or V_{MON} rise above the minimum voltage sense level for time period t_{POR} . This ensures that the voltages have stabilized.

These reset signals provide several benefits:

- It prevents the system microprocessor from starting to operate with insufficient voltage.
- It prevents the processor from operating prior to stabilization of the oscillator.
- It ensures that the monitored device is held out of operation until internal registers are properly loaded.
- It allows time for an FPGA to download its configuration prior to initialization of the circuit.

Adjusting POR Timeout via C_{POR} Pin

On the ISL88011 and ISL88014, users can adjust the Power On Reset timeout delay (t_{POR}) up to many times the normal t_{POR} of 250ms. To do this, connect a capacitor between C_{POR} and ground (see Figure 3). For example, connecting a 30pF capacitor to C_{POR} will increase t_{POR} from a typical 250ms to about 2.5s. **NOTE:** Care should be taken in PCB layout and capacitor placement in order to reduce stray capacitance as much as possible, which lengthens the t_{POR} timeout period.

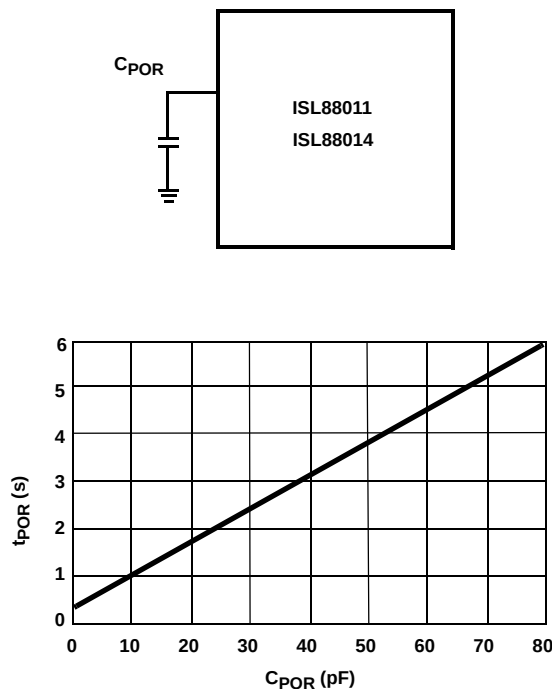


FIGURE 3. ADJUSTING t_{POR} WITH A CAPACITOR

Manual Reset

The manual reset input ($\overline{MR}$) allows the user to trigger a reset by using a push-button switch. The $\overline{MR}$ input is an active-low debounced input. By connecting a push-button directly from $\overline{MR}$ to ground, the designer adds manual system reset capability (see Figure 4). Reset is asserted if the $\overline{MR}$ pin is pulled low to less than 100mV for 1 μ s or longer while the push-button is closed. After $\overline{MR}$ is released, the reset outputs remain asserted for t_{POR} (200ms) and then released.

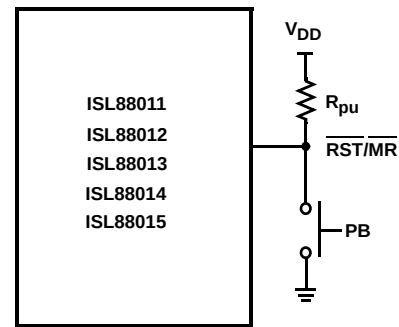


FIGURE 4. CONNECTING A MANUAL RESET PUSH-BUTTON

Watchdog Timer

The Watchdog Timer circuit checks microprocessor activity by monitoring the WDI input pin. The microprocessor must periodically toggle the WDI pin within t_{WDT} (1.6s nominal), otherwise the reset signal is asserted (see Figure 5). Internally, the 1.6s timer is cleared by either a reset or by toggling the WDI input.

Besides the 1.6s default timeout during normal operation, these devices also have a longer 51s timeout for startup. During this time, a reset cannot be asserted due to the WDI not being toggled. The longer delay at power-on allows an operating system to boot, an FPGA to initialize, or the system software to initialize without the burden of dealing with the Watchdog.

Symbol Table

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from LOW to HIGH	Will change from LOW to HIGH
	May change from HIGH to LOW	Will change from HIGH to LOW
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

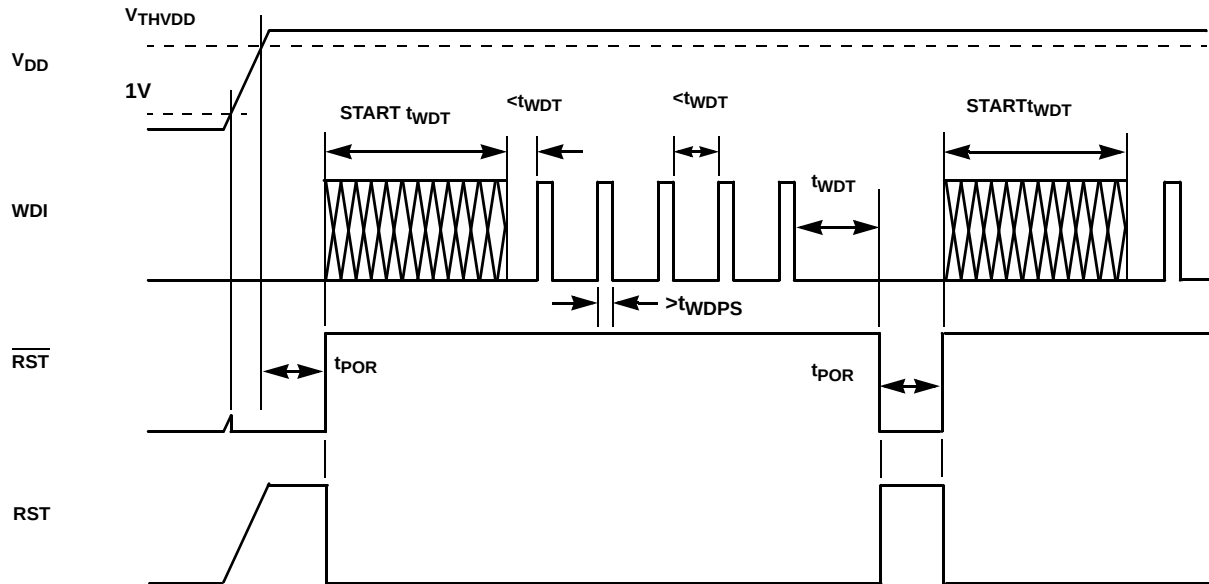


FIGURE 5. WATCHDOG TIMING DIAGRAM

Typical Parametric Performance Curves

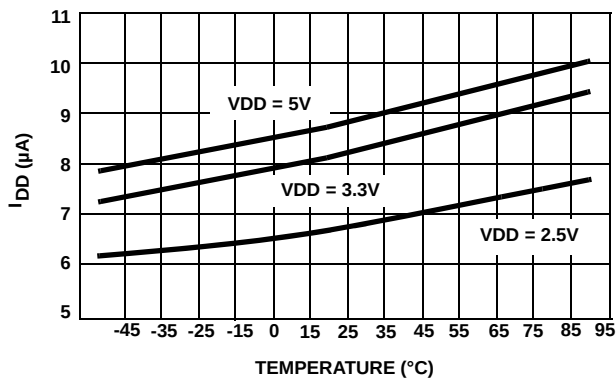


FIGURE 6. I_{DD} (ISL88011, ISL88012, ISL88013) vs TEMPERATURE

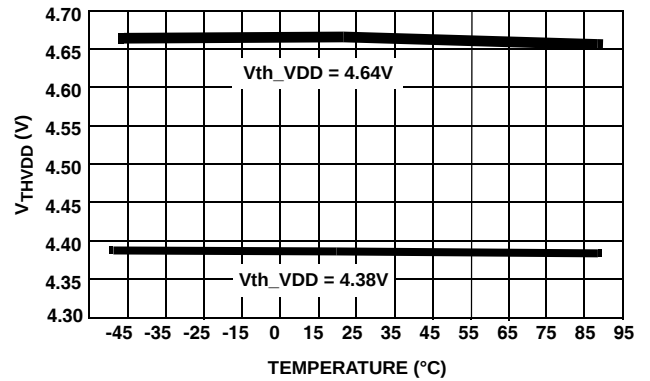


FIGURE 7. V_{THVDD} , $V_{DD} = 5V$ vs TEMPERATURE

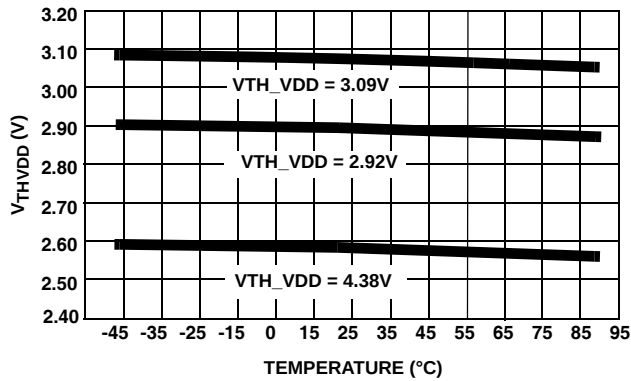


FIGURE 8. V_{THVDD} , $V_{DD} = 3.3V$ vs TEMPERATURE

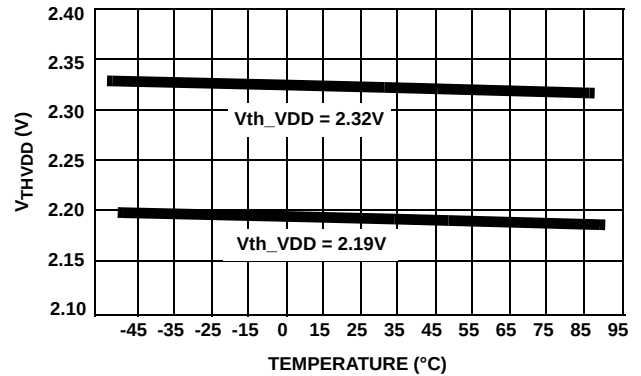


FIGURE 9. V_{THVDD} , $V_{DD} = 2.5V$ vs. TEMPERATURE

Typical Parametric Performance Curves (Continued)

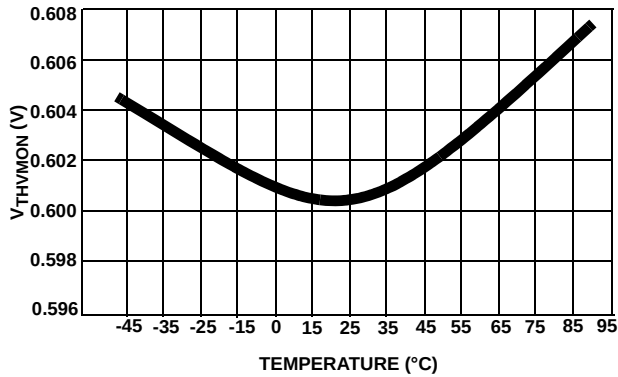


FIGURE 10. V_{THVMON} vs TEMPERATURE

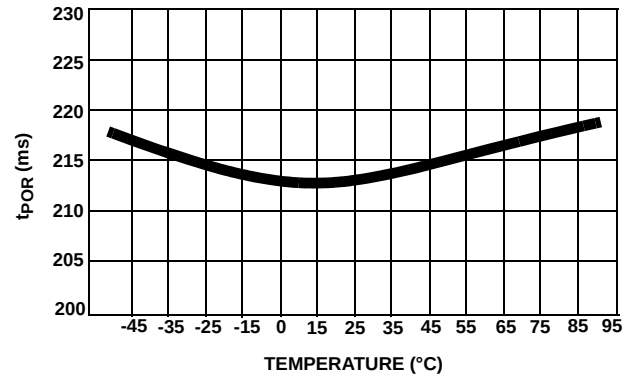


FIGURE 11. t_{POR} (C_{POR} OPEN) vs TEMPERATURE

Typical Application Circuits

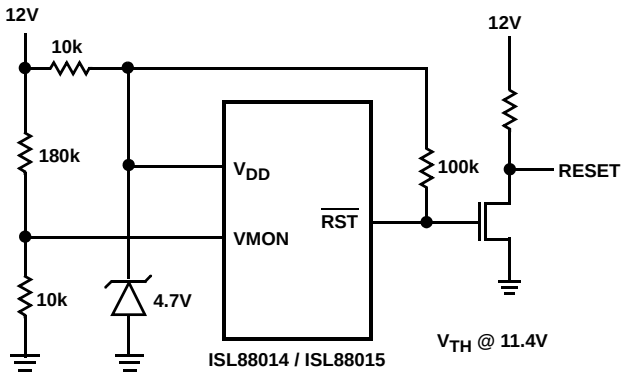


FIGURE 12. HIGH ACCURACY 12V SUPPLY MONITOR

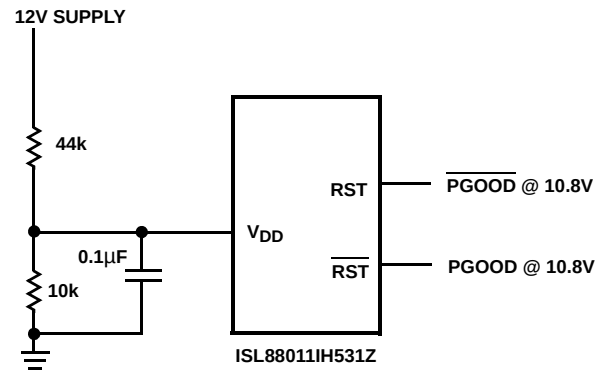


FIGURE 13. 12V SUPPLY PGOOD or $\overline{PGOOD}$

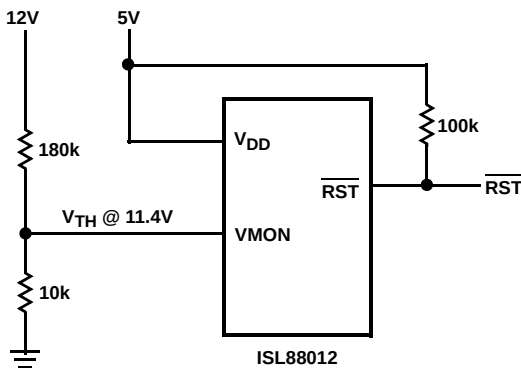
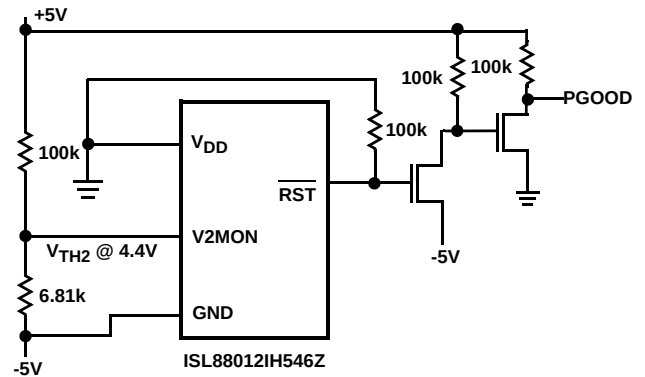


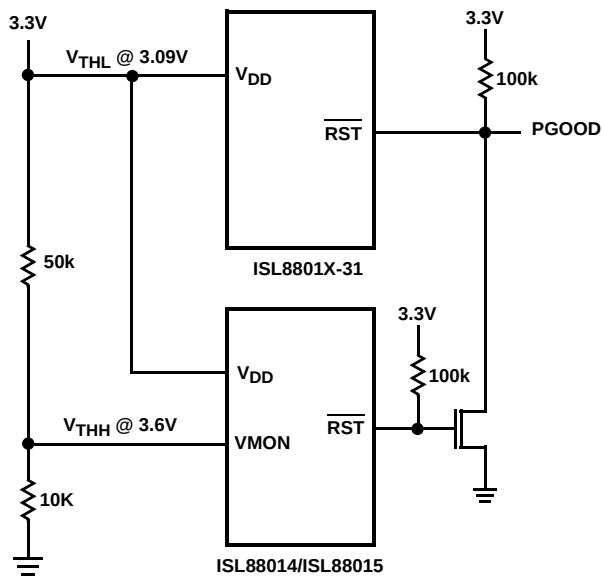
FIGURE 14. MONITOR 5V AND 12V SUPPLIES



$PGOOD = \text{HIGH IF } -V < -4.6V \text{ AND } -V + +V > 9.4 \text{ (abs)}$

FIGURE 15. +5V AND -5V MONITOR

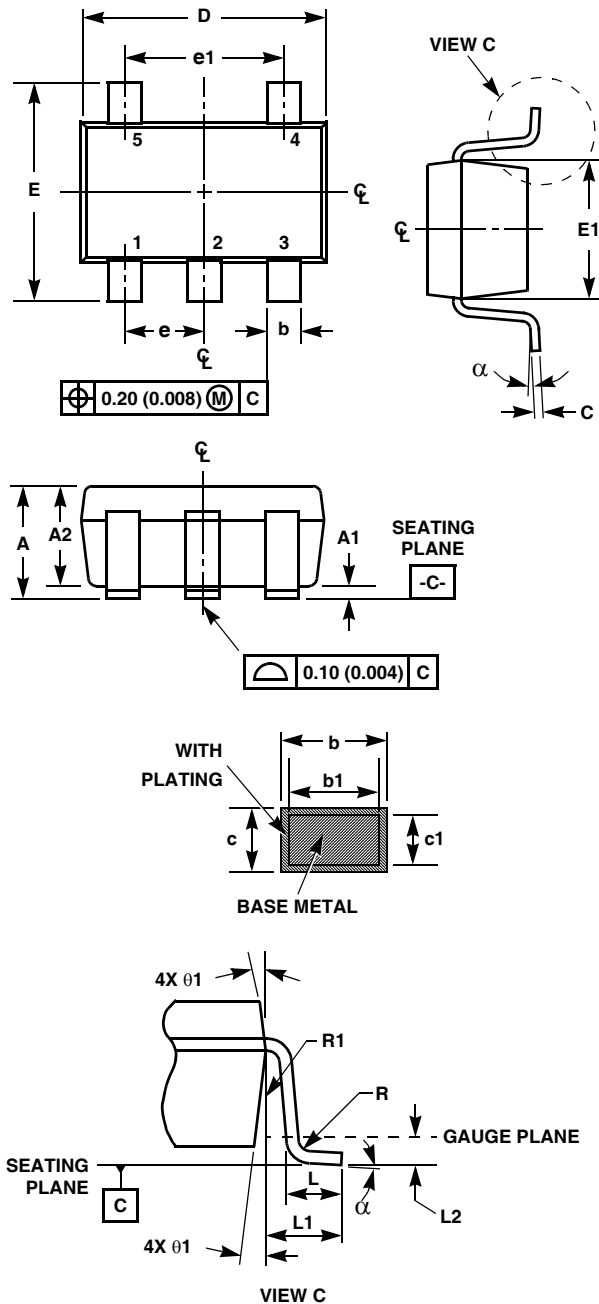
Typical Application Circuits (Continued)



VOLTAGE OUT OF RANGE = P_{GOOD} LOW

FIGURE 16. OVER/UNDERVOLTAGE MONITOR

Small Outline Transistor Plastic Packages (SOT23-5)



P5.064

5 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.036	0.057	0.90	1.45	-
A1	0.000	0.0059	0.00	0.15	-
A2	0.036	0.051	0.90	1.30	-
b	0.012	0.020	0.30	0.50	-
b1	0.012	0.018	0.30	0.45	-
c	0.003	0.009	0.08	0.22	6
c1	0.003	0.008	0.08	0.20	6
D	0.111	0.118	2.80	3.00	3
E	0.103	0.118	2.60	3.00	-
E1	0.060	0.067	1.50	1.70	3
e	0.0374 Ref		0.95 Ref		-
e1	0.0748 Ref		1.90 Ref		-
L	0.014	0.022	0.35	0.55	4
L1	0.024 Ref.		0.60 Ref.		-
L2	0.010 Ref.		0.25 Ref.		-
N	5		5		5
R	0.004	-	0.10	-	-
R1	0.004	0.010	0.10	0.25	-
α	0°	8°	0°	8°	-

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NOTES:

1. Dimensioning and tolerance per ASME Y14.5M-1994.
2. Package conforms to EIAJ SC-74 and JEDEC MO178AA.
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Footlength L measured at reference to gauge plane.
5. "N" is the number of terminal positions.
6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only.

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